

MITSUBISHI Nch POWER MOSFET

FS2KM-16A

HIGH-SPEED SWITCHING USE

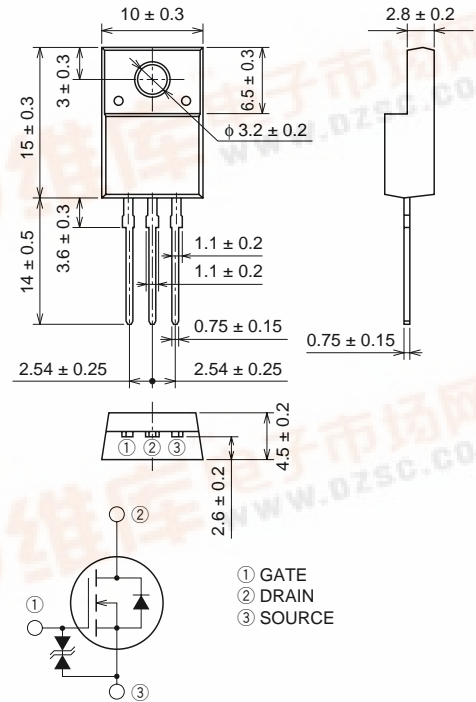
FS2KM-16A



- V_{DSS} 800V
- r_{DS} (ON) (MAX) 6.0Ω
- I_D 2A
- V_{iso} 2000V

OUTLINE DRAWING

Dimensions in mm



TO-220FN

APPLICATION

SMPS, DC-DC Converter, battery charger, power supply of printer, copier, HDD, FDD, TV, VCR, personal computer etc.

MAXIMUM RATINGS (T_c = 25°C)

Symbol	Parameter	Conditions	Ratings	Unit
V _{DSS}	Drain-source voltage	V _{GS} = 0V	800	V
V _{GSS}	Gate-source voltage	V _{DS} = 0V	±30	V
I _D	Drain current		2	A
I _{DM}	Drain current (Pulsed)		6	A
P _D	Maximum power dissipation		30	W
T _{ch}	Channel temperature		-55 ~ +150	°C
T _{stg}	Storage temperature		-55 ~ +150	°C
V _{iso}	Isolation voltage	AC for 1minute, Terminal to case	2000	V _{rms}
—	Weight	Typical value	2	g

FS2KM-16A

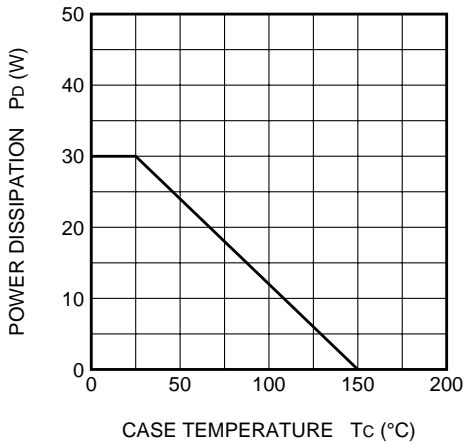
HIGH-SPEED SWITCHING USE

ELECTRICAL CHARACTERISTICS (T_{ch} = 25°C)

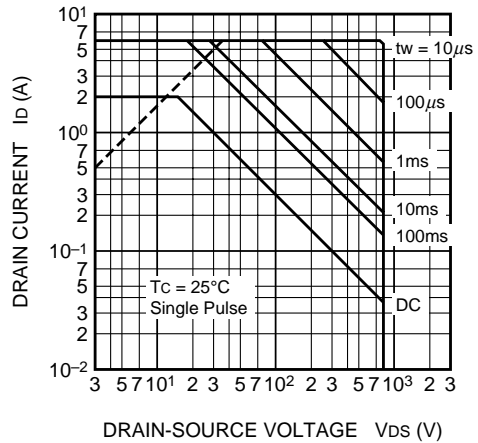
Symbol	Parameter	Test conditions	Limits			Unit
			Min.	Typ.	Max.	
V(BR)DSS	Drain-source breakdown voltage	I _D = 1mA, V _{GS} = 0V	800	—	—	V
V(BR)GSS	Gate-source breakdown voltage	I _{GS} = ±100μA, V _{DS} = 0V	±30	—	—	V
I _{GSS}	Gate-source leakage current	V _{GS} = ±25V, V _{DS} = 0V	—	—	±10	μA
I _{DSS}	Drain-source leakage current	V _{DS} = 800V, V _{GS} = 0V	—	—	1	mA
V _{GS(th)}	Gate-source threshold voltage	I _D = 1mA, V _{DS} = 10V	2	3	4	V
r _{DS(ON)}	Drain-source on-state resistance	I _D = 1A, V _{GS} = 10V	—	4.6	6.0	Ω
V _{DS(ON)}	Drain-source on-state voltage	I _D = 1A, V _{GS} = 10V	—	4.6	6.0	V
y _{fs}	Forward transfer admittance	I _D = 1A, V _{DS} = 10V	1.2	2.0	—	S
C _{iss}	Input capacitance	V _{DS} = 25V, V _{GS} = 0V, f = 1MHz	—	460	—	pF
C _{oss}	Output capacitance		—	45	—	pF
C _{rss}	Reverse transfer capacitance		—	8	—	pF
t _{d(on)}	Turn-on delay time	V _{DD} = 200V, I _D = 1A, V _{GS} = 10V, R _{GEN} = R _{GS} = 50Ω	—	11	—	ns
t _r	Rise time		—	13	—	ns
t _{d(off)}	Turn-off delay time		—	55	—	ns
t _f	Fall time		—	22	—	ns
V _{SD}	Source-drain voltage		I _S = 1A, V _{GS} = 0V	—	1.0	1.5
R _{th(ch-c)}	Thermal resistance	Channel to case	—	—	4.17	°C/W

PERFORMANCE CURVES

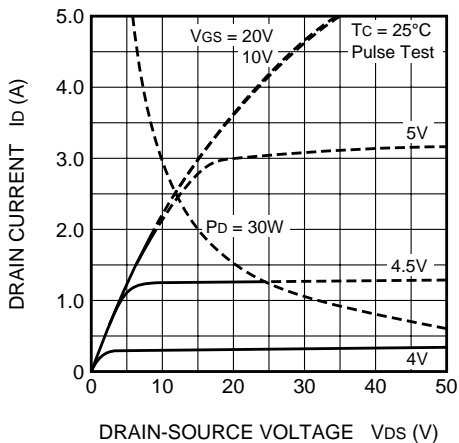
POWER DISSIPATION DERATING CURVE



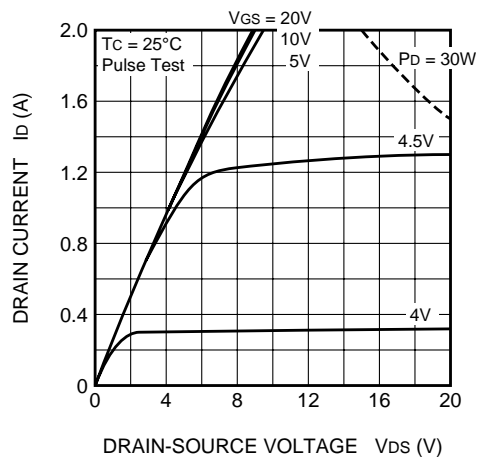
MAXIMUM SAFE OPERATING AREA



OUTPUT CHARACTERISTICS (TYPICAL)

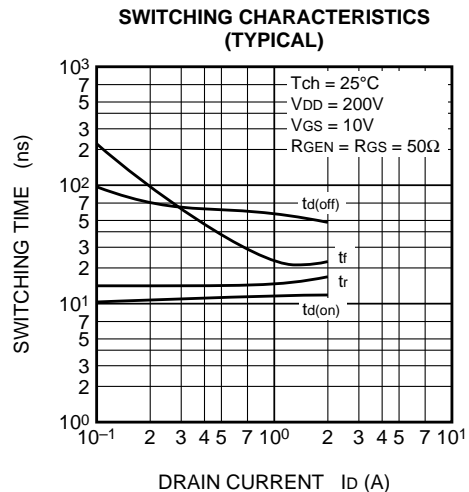
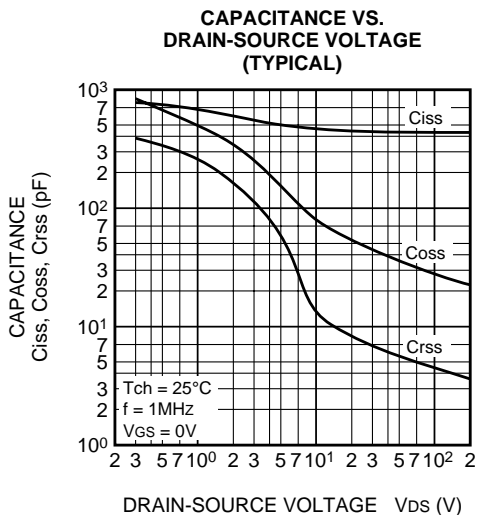
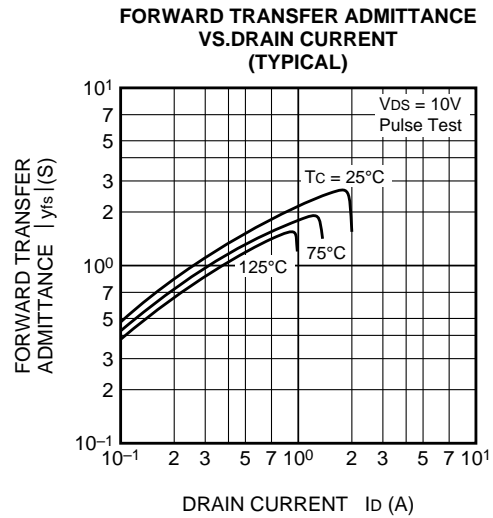
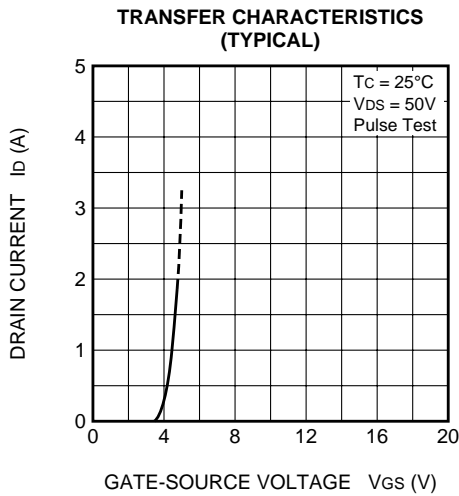
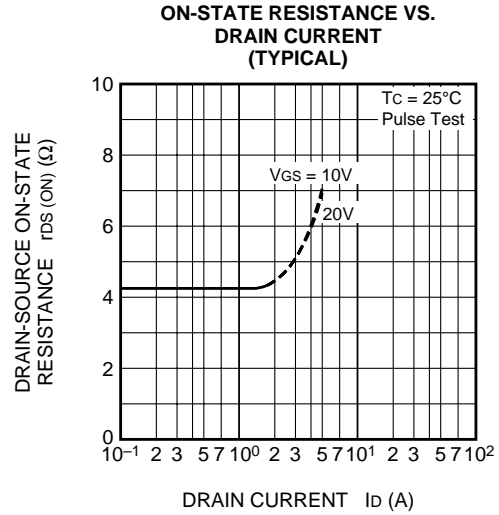
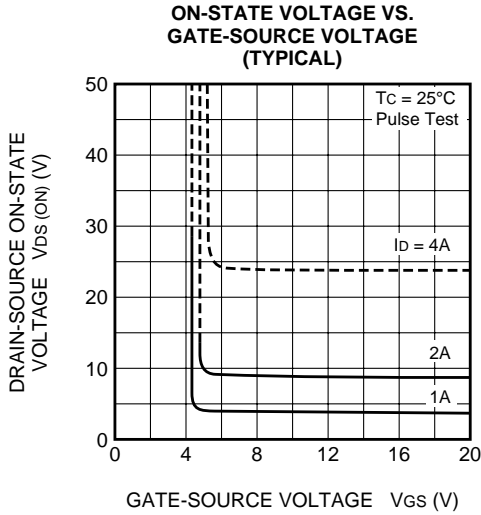


OUTPUT CHARACTERISTICS (TYPICAL)



FS2KM-16A

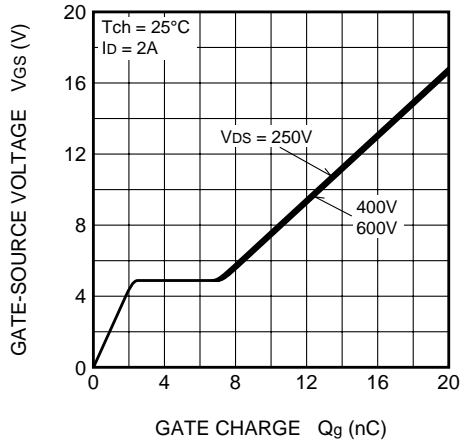
HIGH-SPEED SWITCHING USE



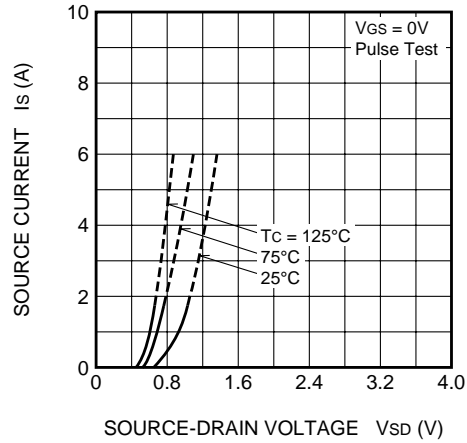
FS2KM-16A

HIGH-SPEED SWITCHING USE

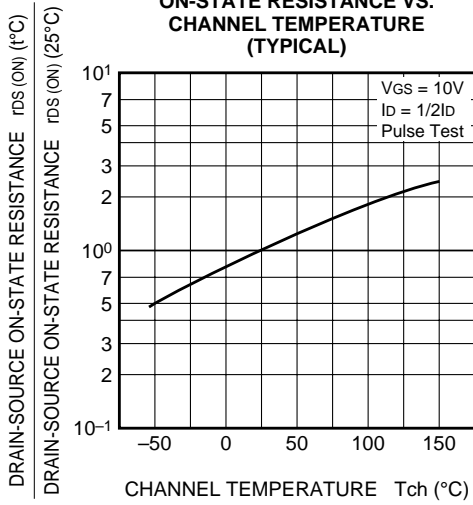
GATE-SOURCE VOLTAGE VS. GATE CHARGE (TYPICAL)



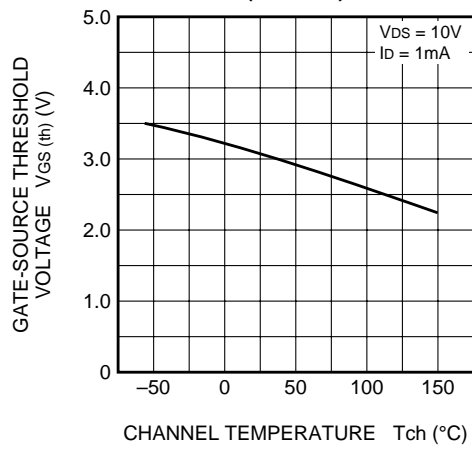
SOURCE-DRAIN DIODE FORWARD CHARACTERISTICS (TYPICAL)



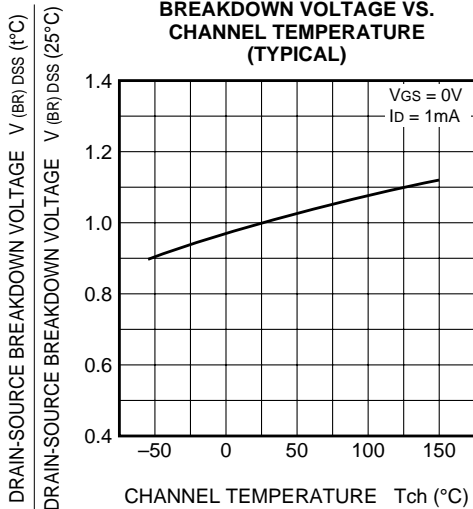
ON-STATE RESISTANCE VS. CHANNEL TEMPERATURE (TYPICAL)



THRESHOLD VOLTAGE VS. CHANNEL TEMPERATURE (TYPICAL)



BREAKDOWN VOLTAGE VS. CHANNEL TEMPERATURE (TYPICAL)



TRANSIENT THERMAL IMPEDANCE CHARACTERISTICS

